SWITCHMODE™ Power Rectifier

The SWITCHMODE power rectifier, a state-of-the-art device, employs the use of the Schottky Barrier principle with a Platinum barrier metal.

Features

- Dual Diode Construction; Terminals 1 and 3 May Be Connected for Parallel Operation at Full Rating
- 30 V Blocking Voltage
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability
- 175°C Operating Junction Temperature
- Pb-Free Package is Available*

Mechanical Characteristics

- Case: Epoxy, Molded. Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight: 4.3 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- ESD Ratings: Machine Model, B (< 400 V) Human Body Model, 3B (> 8000 V)

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	30	V
Average Rectified Forward Current (Rated V_R , $T_C = 100$ °C) Per Leg Per Device	I _{F(AV)}	35 70	Α
Peak Repetitive Forward Current, (Rated V _R , Square Wave, 20 kHz, T _C = 100°C)	I _{FRM}	70	Α
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	500	Α
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz)	I _{RRM}	2.0	Α
Storage Temperature Range	T _{stg}	-55 to +175	°C
Operating Junction Temperature (Note 1)	TJ	-55 to +175	°C
Voltage Rate of Change (Rated V _R)	dv/dt	10,000	V/μs

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. The heat generated must be less than the thermal conductivity from

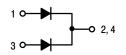
 $\label{eq:Junction} Junction-to-Ambient: dP_D/dT_J < 1/R_{\theta JA}. $$$ *For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

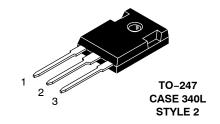


ON Semiconductor®

http://onsemi.com

SCHOTTKY BARRIER RECTIFIER 70 AMPERES, 30 VOLTS





MARKING DIAGRAM



= Assembly Location = Year = Work Week WW = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping
MBR7030WT	TO-247	30 Units/Rail
MBR7030WTG	TO-247 (Pb-Free)	30 Units/Rail

1

THERMAL CHARACTERISTICS (Per Diode)

Rating	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	0.55	°C/W
ELECTRICAL CHARACTERISTICS (Per Diode)			
Instantaneous Forward Voltage (Note 2) @ $I_F = 35$ Amps, $T_C = 25^{\circ}C$ @ $I_F = 70$ Amps, $T_C = 25^{\circ}C$ @ $I_F = 35$ Amps, $T_C = 100^{\circ}C$	V _F	0.55 0.72 0.52	V
Instantaneous Reverse Current (Note 2) @ Rated DC Voltage, T _C = 25°C	I _R	5.0	mA

^{2.} Pulse Test: Pulse Width = 300 μs, Duty Cycle < 2.0%

@ Rated DC Voltage, T_C = 100°C

TYPICAL CHARACTERISTICS

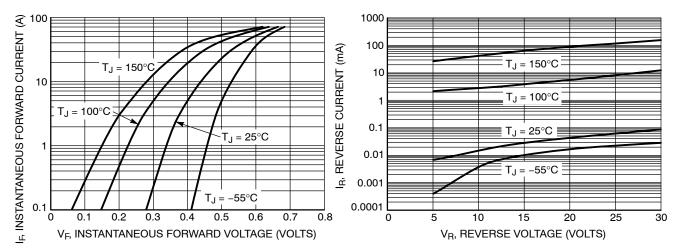
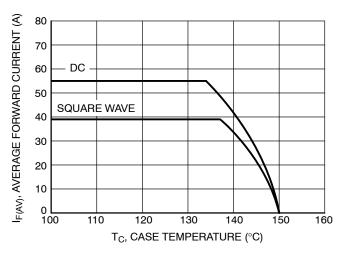


Figure 1. Typical Forward Voltage

Figure 2. Typical Reverse Current

250

TYPICAL CHARACTERISTICS



 $P_{F(AV)}$, AVERAGE POWER DISSIPATION (WATTS) 45 40 35 SQUARE 30 WAVE 25 20 DC 15 10 5 30 40 50 60 $I_{F(AV)}$, AVERAGE FORWARD CURRENT (AMPS)

Figure 3. Current Derating (Case)

Figure 4. Forward Power Dissipation (Per Leg)

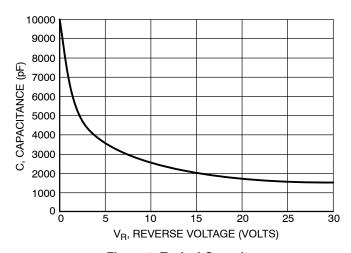
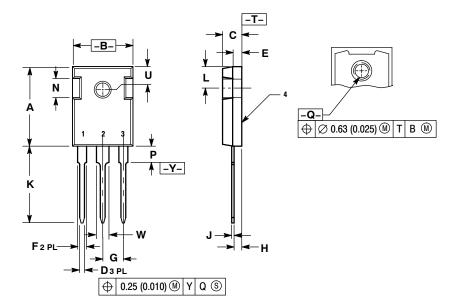


Figure 5. Typical Capacitance

PACKAGE DIMENSIONS

TO-247 CASE 340L-02 ISSUE E



NOTES

- DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	20.32	21.08	0.800	8.30
В	15.75	16.26	0.620	0.640
С	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
Е	1.90	2.60	0.075	0.102
F	1.65	2.13	0.065	0.084
G	5.45 BSC		0.215 BSC	
Н	1.50	2.49	0.059	0.098
J	0.40	0.80	0.016	0.031
K	19.81	20.83	0.780	0.820
L	5.40	6.20	0.212	0.244
N	4.32	5.49	0.170	0.216
Р		4.50		0.177
Q	3.55	3.65	0.140	0.144
U	6.15	3.15 BSC 0.242 BSC		BSC
W	2.87	3.12	0.113	0.123

STYLE 2: PIN 1. ANODE

2. CATHODE (S) 3. ANODE 2

CATHODES (S)

SWITCHMODE is a trademark of Semiconductor Components Industries, LLC.

ON Semiconductor and un are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its partner rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA **Phone**: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative